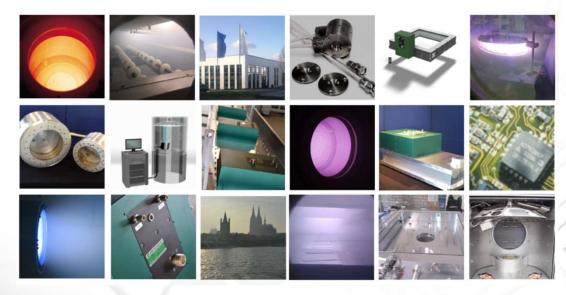


CCR PVD Assist Plasma Source Solutions



Event: Baltic Photonics 2019, VilniusPresenter: Ignazio CiccomascoloDate: 09th of October 2019





Agenda

- i. About CCR Technology
- ii. Technical Basics of the COPRA Plasma Source
 - i. main benefits for PVD Assist
- iii. Different machine designs
 - i. Sputter Assist (PARMS)
 - i. Turn-table coating system
 - ii. Drum-coating systems
 - ii. IBAD
 - i. Example IZOVAC
- iv. Questions



- established in the 90's
- located in Troisdorf nearby cologne
- developer of ICP sources and solutions
- more than 70 different variants of COPRA Sources
- meanwhile approx. 1000 sources shipped in over 40 countries
- more than 3/4 of them in industrial production





Technical Basics of the COPRA Plasma Technology®

Technology: ICP inductive coupled plasma

Frequency: 13.56 MHz RF

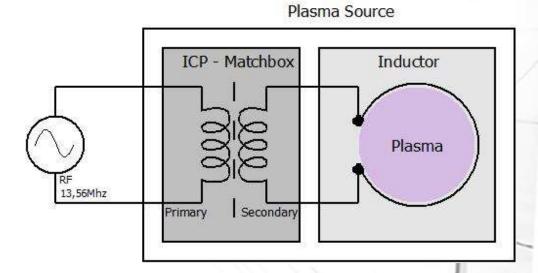
Power: 0.1 to 15 kW

Impedance: 50 Ohm

Matching: "always Integrated Remote Matchbox"

Gas Pressure: 1E-4 mbar to 1E-1 mbar

Gas: almost any

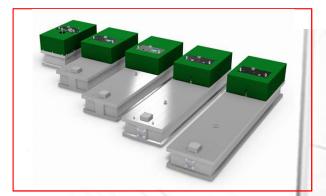


COPRA® RF-ICP-Plasma Solutions









- Competitive, industrial coating solutions
- easy to install (Matchbox integrated), scale and reliable performing



Typical Applications

- PVD-Assist (magnetron sputter assist)
 - cleaning
 - activation
 - oxidation
 - metal oxides, AR-coatings, band-pass-filter, decorative coatings, etc.
 - nitriding
 - densification
- etching (chemical + physical etching, soft etching)



Main benefits of CCR COPRA ICP sources

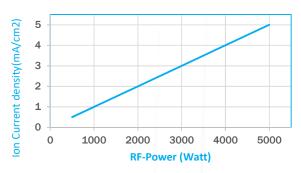
- Optimum operation in the same working pressure level like sputtering
- independent ion-current-density (ICD) control from ion-energy
- the COPRA Plasma Sources can work directly with nearly any gases as also pure gas types as well as gas mixtures. No operation gas is needed.
- Even pure H₂ & SF6 Plasma can be generated easily

Examples for different gas configurations: O₂, N₂, Ar, **H₂** & gas mixtures...



CCR Technology

Ion Current Density vs. RF-Power



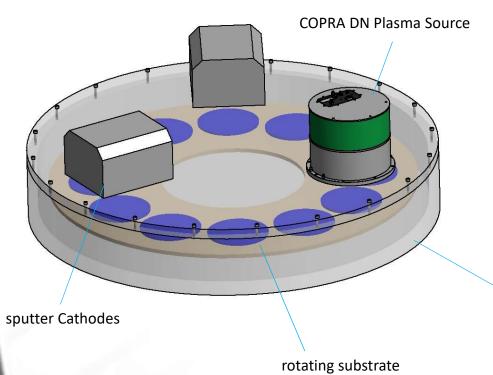
Ion energy vs. RF-Power







Turntable sputter coating-systems





DN160; DN200; DN250



DN251; DN401; DN501



vacuum chamber

table

CCR PVD-Assist Plasma Source Solutions - Baltic Photonics 2019

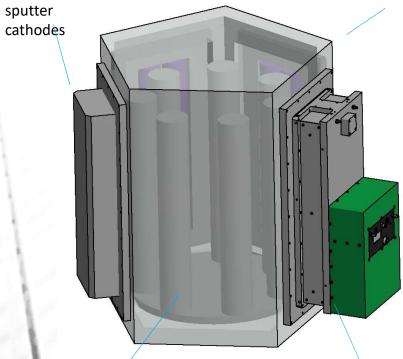
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sputter

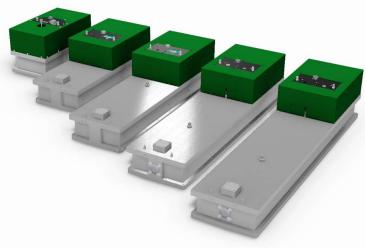
CCR Technology

Drum coating sputter-systems

vacuum chamber







LS358x156; LS1600x201

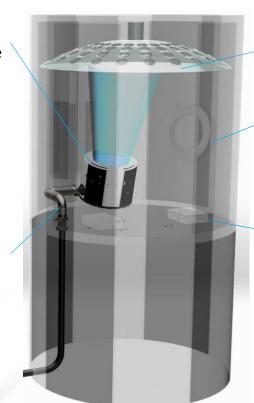
rotating drum/double rotation

COPRA LS Plasma Source

IBAD (E-Beam Assist)

COPRA IS Plasma source

supply lines



calotte or planetary done

vacuum chamber

E-Beam or thermal evaporator

CCR Technology



IS200.....IS501





Example IZOVAC Ortus







www.ccrtechnology.de

